

NCE P-Channel Super Trench Power MOSFET

Description

The NCEP30P90K uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

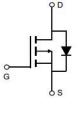
General Features

- V_{DS} =-30V, I_{D} =-90A $R_{DS(ON)}$ =5.7mΩ (typical) @ V_{GS} =-10V $R_{DS(ON)}$ =7.6mΩ (typical) @ V_{GS} =-4.5V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175°C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED! 100% ΔVds TESTED!



Schematic Diagram



Marking and pin assignment



TO-252 -2Ltop view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP30P90K	NCEP30P90K	TO-252-2L	-	-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-30	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	-90	А
Drain Current-Continuous(T _C =100 ℃)	I _D (100℃)	-63	А
Pulsed Drain Current	I _{DM}	-300	А
Maximum Power Dissipation	P _D	90	W
Derating factor		0.6	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	500	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance,Junction-to-Case ^(Note 2)	Rejc	1.67	°C/W	
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-30		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.0	-1.5	-2.2	V
Dunin Sauras On State Besietense	В	V _{GS} =-10V, I _D =-20A	-	5.7	6.3	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-20A	-	7.6	8.5	mΩ
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-20A	-	30	-	S
Dynamic Characteristics (Note4)			,	,		
Input Capacitance	C _{lss}	\\ 45\\\\ 0\\	-	3700	-	PF
Output Capacitance	Coss	V _{DS} =-15V,V _{GS} =0V,	-	880	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	20	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	10.5	-	nS
Turn-on Rise Time	t _r	V _{DD} =-15V,I _D =-20A	-	9	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10V, R_{G} =1.6 Ω	-	40	-	nS
Turn-Off Fall Time	t _f		-	10	-	nS
Total Gate Charge	Qg	\/ 45\/\ 004	-	57	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-15V,I _D =-20A,	-	9.8		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	7.3		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-20A	-		-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-90	А
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F =-20A	-		24	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-		68	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=-15V,VG=-10V,L=0.5mH,Rg=25 Ω



Typical Electrical and Thermal Characteristics

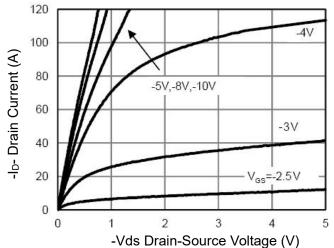


Figure 1 Output Characteristics

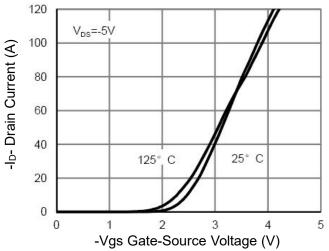


Figure 2 Transfer Characteristics

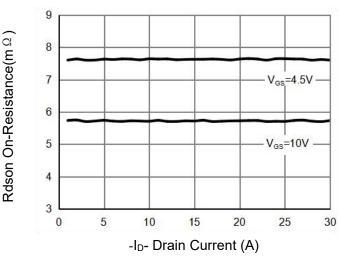


Figure 3 Rdson- Drain Current

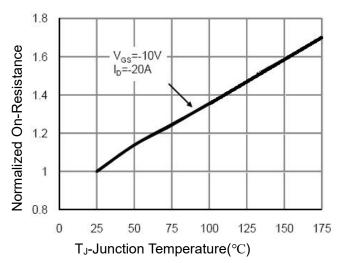


Figure 4 Rdson-JunctionTemperature

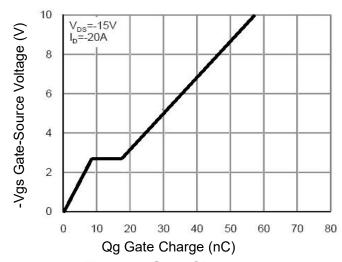


Figure 5 Gate Charge

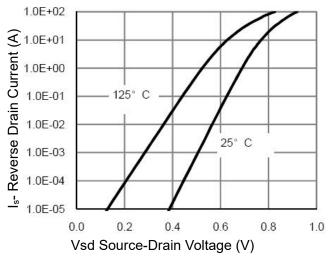


Figure 6 Source- Drain Diode Forward



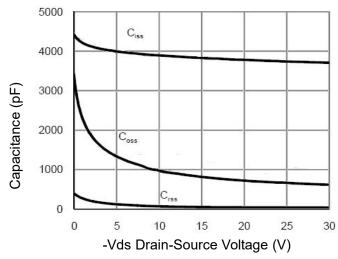


Figure 7 Capacitance vs Vds

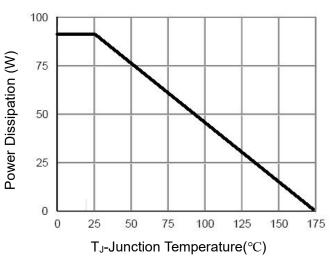


Figure 9 Power De-rating

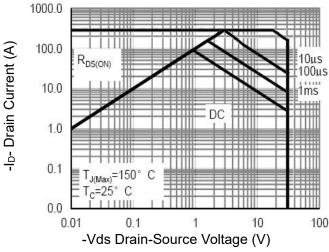


Figure 8 Safe Operation Area

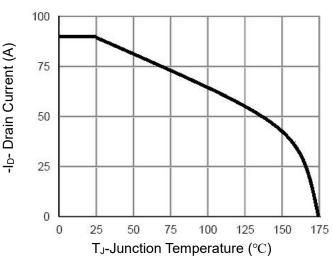


Figure 10 Current De-rating

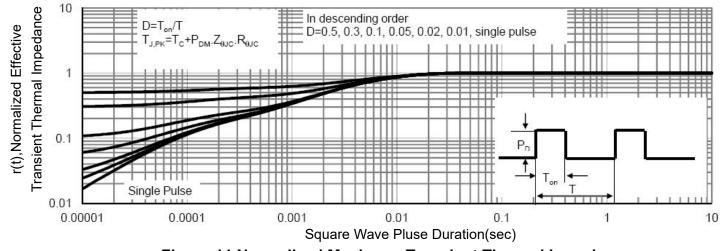
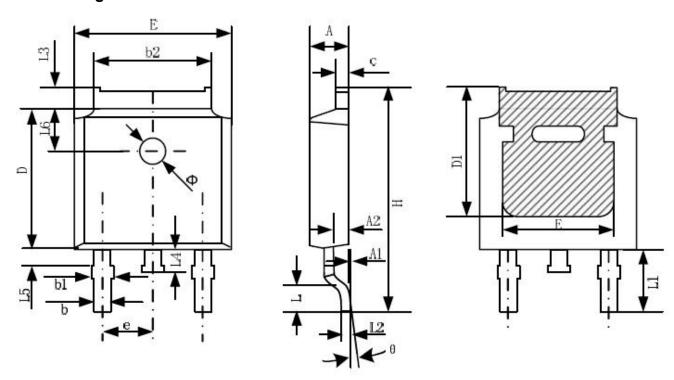


Figure 11 Normalized Maximum Transient Thermal Impedance



TO-252-2L Package Information



Completed.	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.20	2.38	0.087	0.094	
A1	0.00	0.10	MOSEC		
A2	0.90	1.10	0.035	0.043	
b	0.72	0.85	0.028	0.033	
b1	0.72	0.90	0.028	0.035	
b2	5.13	5.46	0.202	0.215	
С	0.47	0.60	0.019	0.024	
D	6.00	6.20	0.236	0.244	
D1	5.25	-	0.207	-	
E	6.50	6.70	0.256	0.264	
E1	4.70	120	0.185	¥3	
e	2.19	2.39	0.086	0.094	
Н	9.80	10.40	0.386	0.409	
L	1.40	1.70	0.055	0.067	
L1	2.90	REF	0.114	114 REF	
L2	0.508 BSC		0.020) BSC	
L3	0.90	1.25	0.035	0.049	
L4	0.60	1.00	0.024	0.039	
L5	0.15	0.75	0.006	0.030	
L6	1.80 REF		0.071 REF		
Φ	1.20	1.40	0.047	0.055	
θ	0°	8°	0°	8°	

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NCEP30P90K

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